

# SKM1400GAL17R8



SEMITRANS® 10

## IGBT R8 Modules

### SKM1400GAL17R8

#### Features\*

- Symmetrical current sharing
- Low-inductive module design
- High mechanical robustness
- UL recognized, file no. E63532

#### Typical Applications

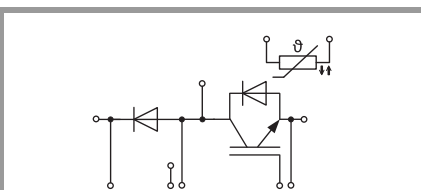
- Brake chopper
- Windturbines

#### Remarks

Recommended  $T_{jop} = -40 \dots +150^{\circ}\text{C}$

Absolute Maximum Ratings				
Symbol	Conditions		Values	Unit
<b>IGBT</b>				
$V_{CES}$	$T_j = 25^{\circ}\text{C}$		1700	V
$I_C$	$T_j = 175^{\circ}\text{C}$	$T_c = 25^{\circ}\text{C}$	2337	A
		$T_c = 100^{\circ}\text{C}$	1527	A
$I_{Cnom}$			1400	A
$I_{CRM}$			2800	A
$V_{GES}$			-20 ... 20	V
$t_{psc}$	$V_{CC} = 1200\text{ V}$	$T_j = 150^{\circ}\text{C}$	10	$\mu\text{s}$
	$V_{GE} \leq 15\text{ V}$			
	$V_{CES} \leq 1700\text{ V}$			
$T_j$			-40 ... 175	$^{\circ}\text{C}$
<b>Inverse diode</b>				
$V_{RRM}$	$T_j = 25^{\circ}\text{C}$		1700	V
$I_F$	$T_j = 175^{\circ}\text{C}$	$T_c = 25^{\circ}\text{C}$	1874	A
		$T_c = 100^{\circ}\text{C}$	1168	A
$I_{FRM}$			2800	A
$I_{FSM}$	$t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 25^{\circ}\text{C}$		9024	A
$T_j$			-40 ... 175	$^{\circ}\text{C}$
<b>Freewheeling diode</b>				
$V_{RRM}$	$T_j = 25^{\circ}\text{C}$		1700	V
$I_F$	$T_j = 175^{\circ}\text{C}$	$T_c = 25^{\circ}\text{C}$	1874	A
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$I_{FRM}$			2800	A
$I_{FSM}$	$t_p = 10\text{ ms, sin } 180^{\circ}, T_j = 25^{\circ}\text{C}$		9024	A
$T_j$			-40 ... 175	$^{\circ}\text{C}$
<b>Module</b>				
$T_{stg}$			-40 ... 150	$^{\circ}\text{C}$
$V_{isol}$	AC sinus 50 Hz, $t = 1\text{ min}$		4000	V

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
<b>IGBT</b>						
$V_{CE(sat)}$	$I_C = 1400\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^{\circ}\text{C}$	1.63	1.95		V
		$T_j = 150^{\circ}\text{C}$	1.96	2.27		V
$V_{CE0}$	chipelevel	$T_j = 25^{\circ}\text{C}$	1.06	1.12		V
		$T_j = 150^{\circ}\text{C}$	0.95	1.05		V
$r_{CE}$	$V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^{\circ}\text{C}$	0.41	0.59		$\text{m}\Omega$
		$T_j = 150^{\circ}\text{C}$	0.72	0.87		$\text{m}\Omega$
$V_{GE(th)}$	$V_{CE} = 10\text{ V}, I_C = 52.8\text{ mA}$		5	5.8	6.5	V
$I_{CES}$	$V_{GE} = 0\text{ V}, V_{CE} = 1700\text{ V}, T_j = 25^{\circ}\text{C}$				6.0	mA
$C_{ies}$	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	139.2			nF
$C_{oes}$		$f = 1\text{ MHz}$	4.80			nF
$C_{res}$		$f = 1\text{ MHz}$	0.43			nF
$Q_G$	$V_{GE} = -15\text{ V} \dots +15\text{ V}$		8640			nC
$R_{Gint}$	$T_j = 25^{\circ}\text{C}$		1.3			$\Omega$



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# SKM1400GAL17R8



**SEMITRANS® 10**

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#### Features\*

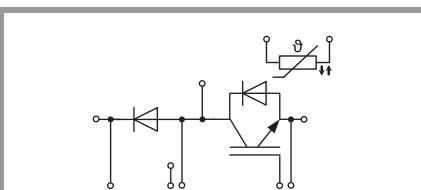
- Symmetrical current sharing
- Low-inductive module design
- High mechanical robustness
- UL recognized, file no. E63532

#### Typical Applications

- Brake chopper
- Windturbines

#### Remarks

Recommended  $T_{jop} = -40 \dots +150^\circ\text{C}$



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Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
<b>IGBT</b>					
$t_{d(on)}$	$V_{CC} = 900\text{ V}$	$T_j = 150^\circ\text{C}$	536		ns
$t_r$	$I_C = 1400\text{ A}$	$T_j = 150^\circ\text{C}$	127		ns
$E_{on}$	$V_{GE} = +15/-15\text{ V}$ $R_{G\ on} = 0.67\ \Omega$	$T_j = 150^\circ\text{C}$	645		mJ
$t_{d(off)}$	$R_{G\ off} = 0.5\ \Omega$	$T_j = 150^\circ\text{C}$	645		ns
$t_f$	$di/dt_{on} = 10.4\text{ kA}/\mu\text{s}$	$T_j = 150^\circ\text{C}$	215		ns
$E_{off}$	$di/dt_{off} = 6.8\text{ kA}/\mu\text{s}$ $dv/dt = 3100\text{ V}/\mu\text{s}$ $L_s = 36\text{ nH}$	$T_j = 150^\circ\text{C}$	482		mJ
$R_{th(j-c)}$	per IGBT			0.02	K/W
$R_{th(c-s)}$	per IGBT ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.01		K/W
<b>Inverse diode</b>					
$V_F = V_{EC}$	$I_F = 1400\text{ A}$	$T_j = 25^\circ\text{C}$	1.84	2.19	V
	$V_{GE} = 0\text{ V}$ chiplevel	$T_j = 150^\circ\text{C}$	1.89	2.25	V
$V_{F0}$	chiplevel	$T_j = 25^\circ\text{C}$	1.32	1.56	V
		$T_j = 150^\circ\text{C}$	1.08	1.22	V
$r_F$	chiplevel	$T_j = 25^\circ\text{C}$	0.37	0.45	m $\Omega$
		$T_j = 150^\circ\text{C}$	0.58	0.74	m $\Omega$
$I_{RRM}$	$I_F = 1400\text{ A}$	$T_j = 150^\circ\text{C}$	1025		A
$Q_{rr}$	$V_{GE} = -15\text{ V}$ $di/dt_{off} = 10.4\text{ kA}/\mu\text{s}$	$T_j = 150^\circ\text{C}$	486		$\mu\text{C}$
$E_{rr}$	$\mu\text{s}$ $V_R = 900\text{ V}$	$T_j = 150^\circ\text{C}$	236		mJ
$R_{th(j-c)}$	per diode			0.032	K/W
$R_{th(c-s)}$	per diode ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.013		K/W
<b>Freewheeling diode</b>					
$V_F = V_{EC}$	$I_F = 1400\text{ A}$	$T_j = 25^\circ\text{C}$	1.84	2.19	V
	$V_{GE} = 0\text{ V}$ level = chiplevel	$T_j = 150^\circ\text{C}$	1.89	2.25	V
$V_{F0}$	chiplevel	$T_j = 25^\circ\text{C}$	1.32	1.56	V
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$R_{th(j-c)}$	per diode			0.032	K/W
$R_{th(c-s)}$	per diode ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.013		K/W
<b>Module</b>					
$L_{CE}$			10		nH
$R_{CC+EE}$	measured per switch, $T_C = 25^\circ\text{C}$		0.2		m $\Omega$
$R_{th(c-s)1}$	calculated without thermal coupling ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.0028		K/W
$R_{th(c-s)2}$	including thermal coupling, $T_s$ underneath module ( $\lambda_{grease} = 0.81\text{ W}/(\text{m}^2\text{K})$ )		0.005		K/W
$M_s$	to heat sink M5		4	6	Nm
$M_t$		to terminals M8	8	10	Nm
		to terminals M4	1.8	2.1	Nm
$w$				1250	g

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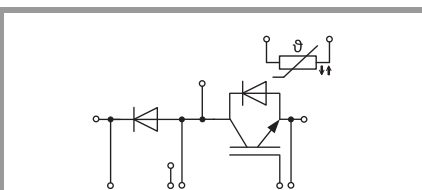
- Brake chopper
- Windturbines

#### Remarks

Recommended  $T_{jop} = -40 \dots +150^{\circ}\text{C}$

#### Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
<b>Temperature Sensor</b>					
$R_{100}$	$T_c=100^{\circ}\text{C}$ ( $R_{25}=5 \text{ k}\Omega$ )		$493 \pm 5\%$		$\Omega$
$B_{100/125}$	$R(T)=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$ ; $T[\text{K}]$ ;		$3550 \pm 2\%$		K



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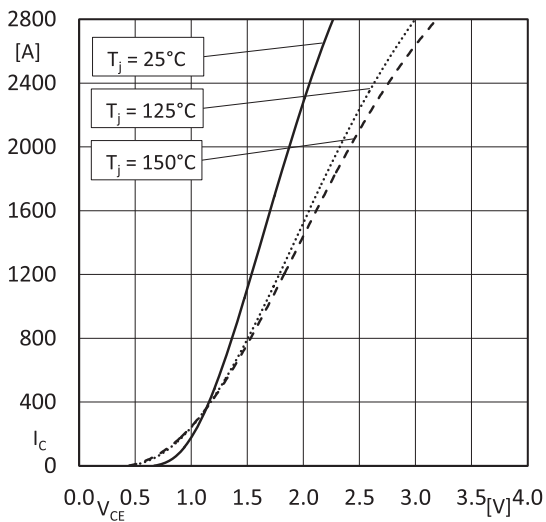


Fig. 1: Output characteristics IGBT (typical);  $I_C = f(V_{CE})$ ;  $V_{GE} = 15V$ ; (chipllevel)

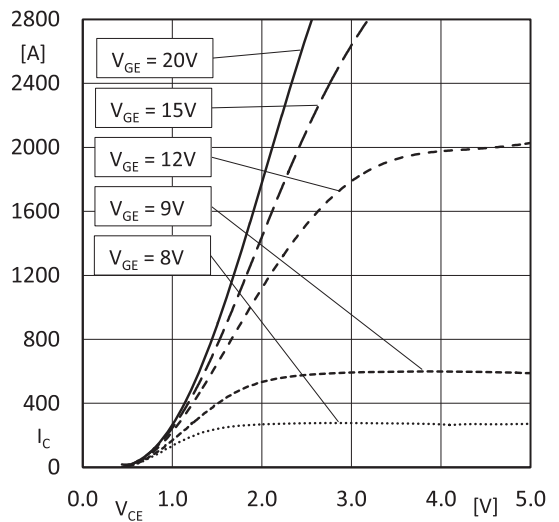


Fig. 2: Output characteristics IGBT (typical);  $I_C = f(V_{CE})$ ;  $T_j = 150^\circ C$ ; (chipllevel)

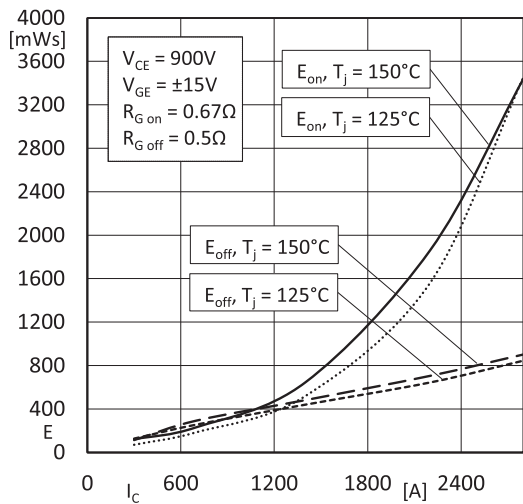


Fig. 3: Switching losses IGBT (typical);  $E=f(I_C)$

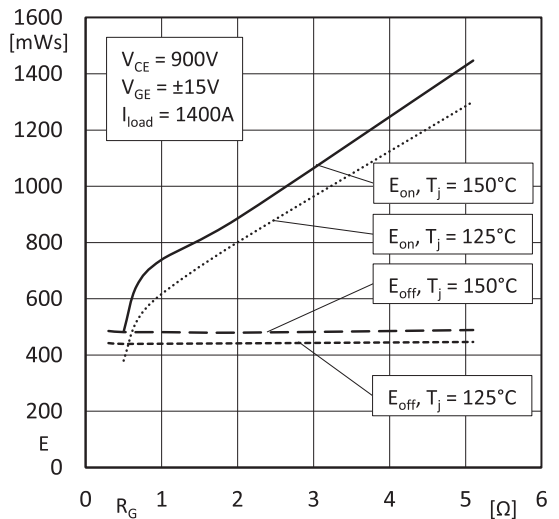


Fig. 4: Switching losses IGBT (typical);  $E=f(R_G)$

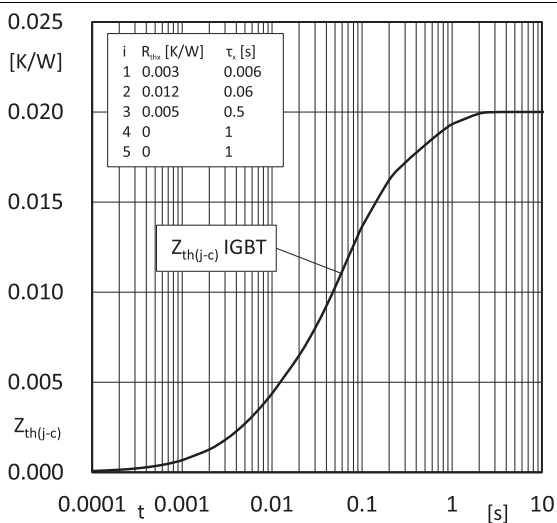


Fig. 5: Transient thermal impedance IGBT

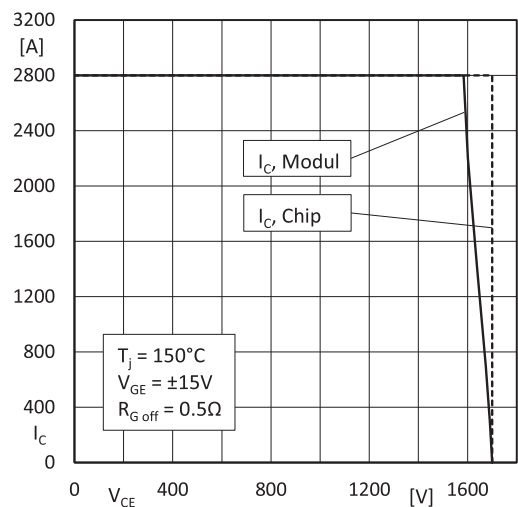


Fig. 6: RBSOA IGBT

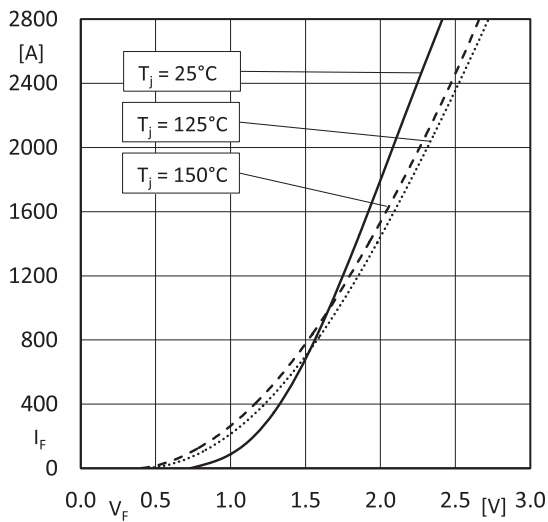


Fig. 7: Forward charact. Diode (typical);  $I_F=f(V_F)$ ; (chipllevel)

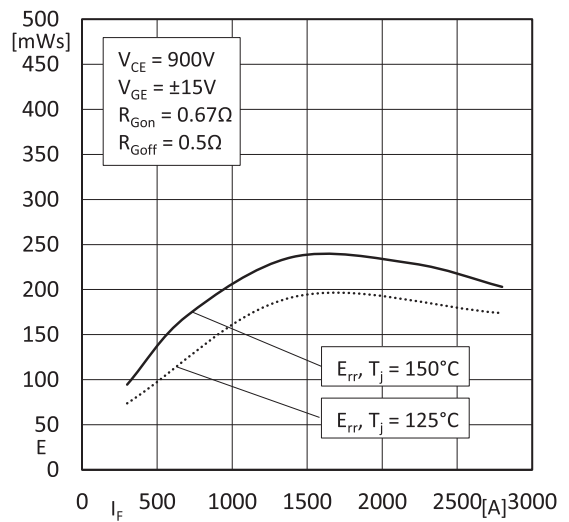


Fig. 8: Switching losses Diode (typical);  $E=f(I_F)$

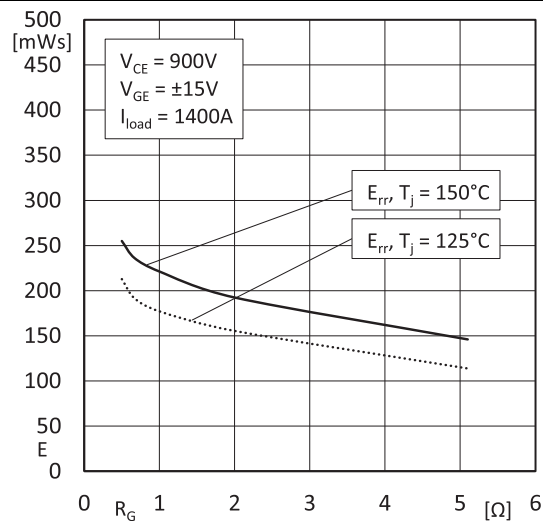


Fig. 9: Switching losses Diode (typical);  $E=f(R_G)$

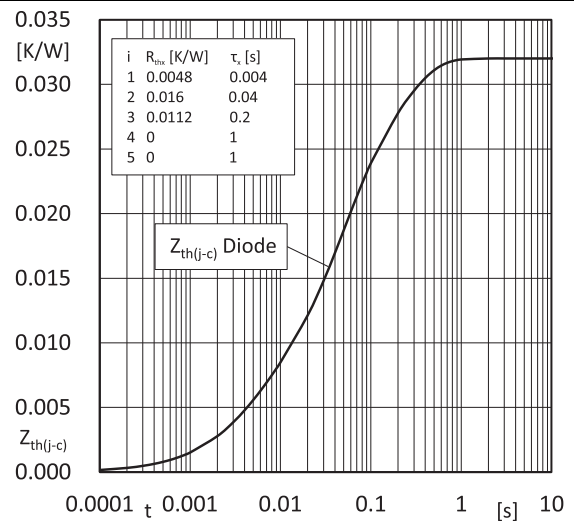


Fig. 10: Transient thermal impedance Diode

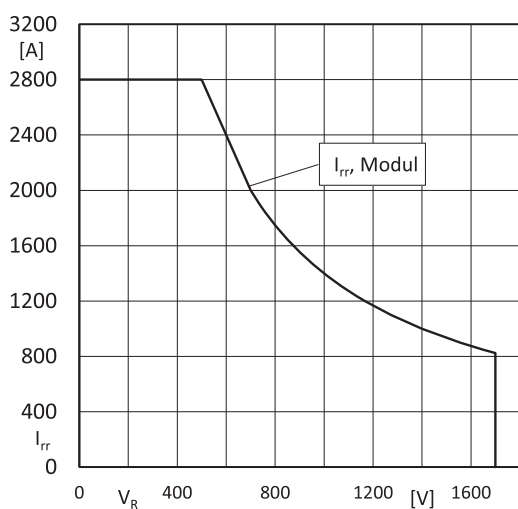


Fig. 11: RBSOA Diode

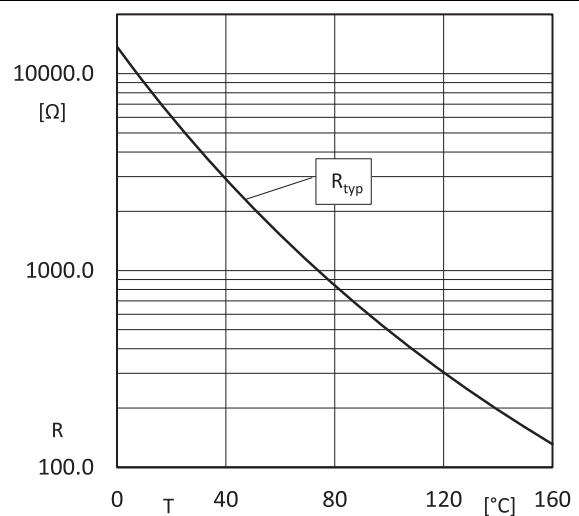


Fig. 12: NTC characteristics (typical)

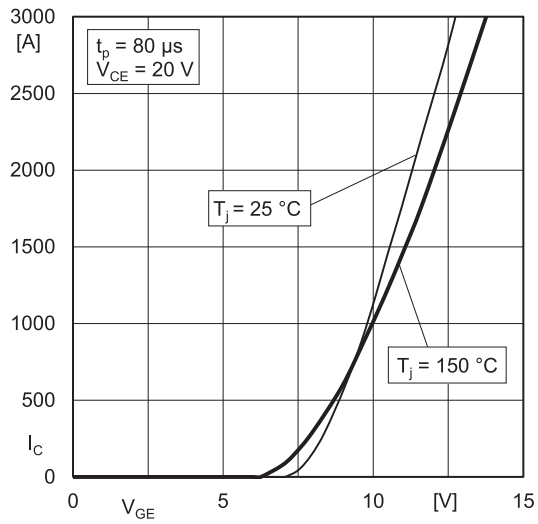


Fig. 13: Typ. transfer characteristic

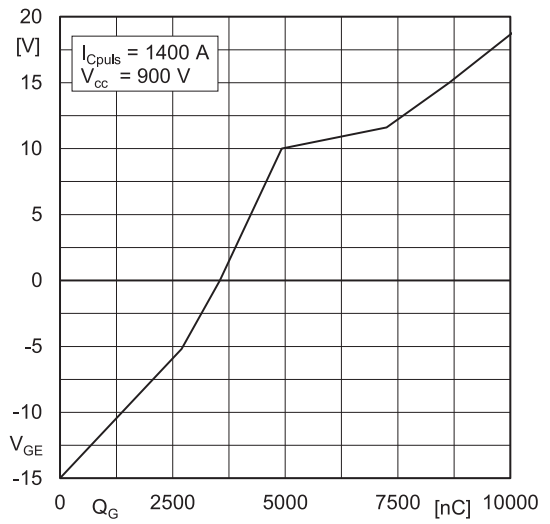
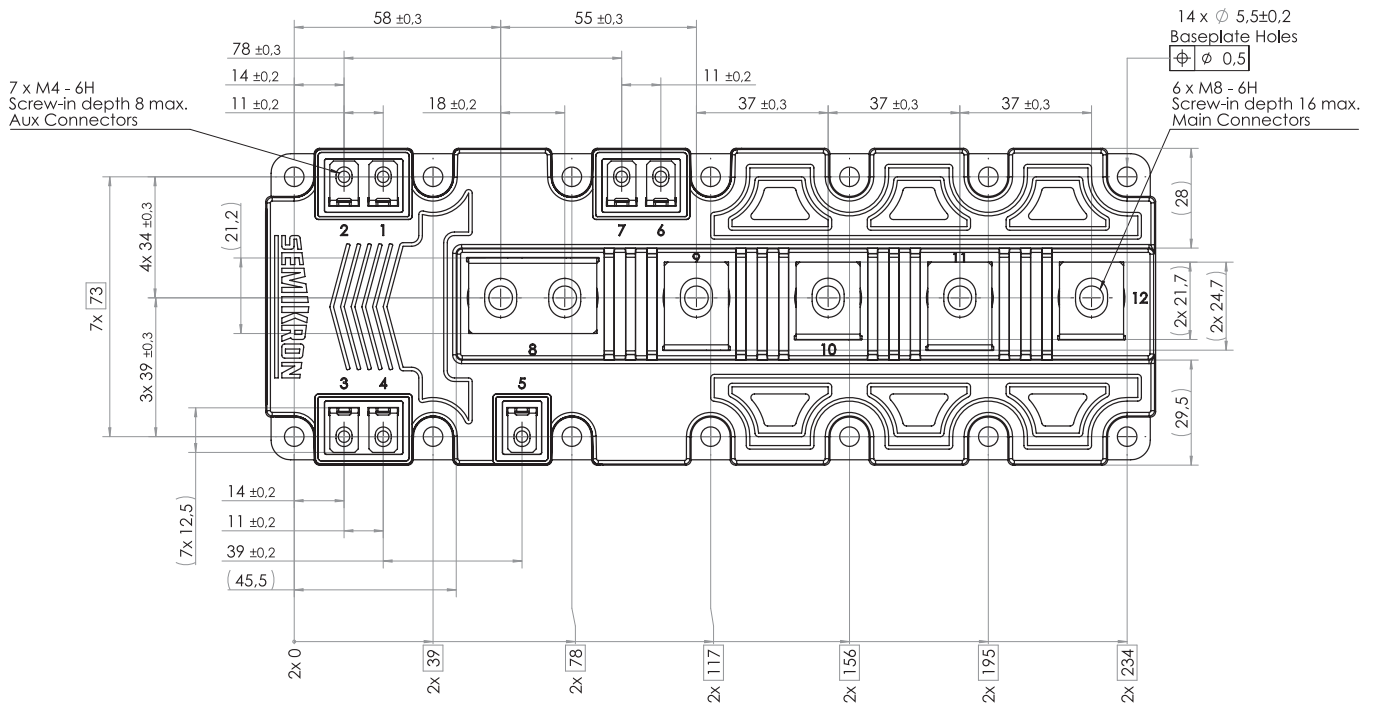
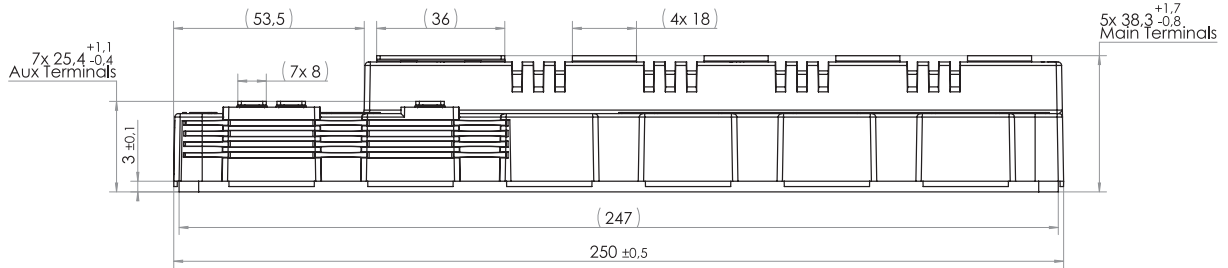
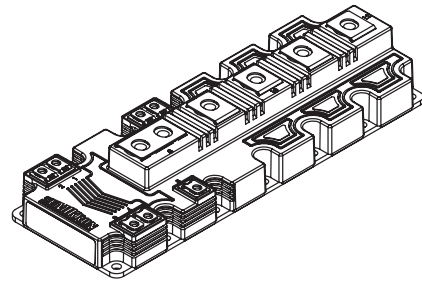
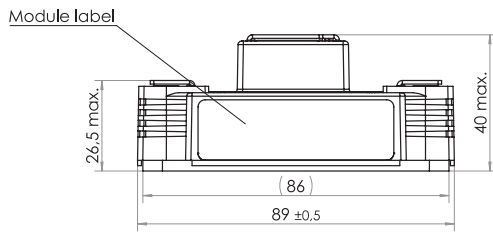


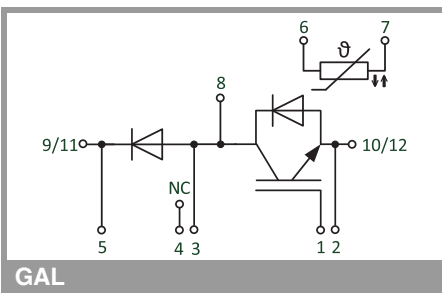
Fig. 14: Typ. gate charge characteristic

# SKM1400GAL17R8



- Dimensions in mm
- General tolerances  $\pm 0.5\text{mm}$

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This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

## **\*IMPORTANT INFORMATION AND WARNINGS**

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